



US00D331408S

United States Patent [19]

Ellermeier

[11] Patent Number: **Des. 331,408**

[45] Date of Patent: **** Dec. 1, 1992**

[54] **HEADPHONE**

[75] Inventor: **Konrad Ellermeier, Gaaden, Austria**

[73] Assignee: **U.S. Philips Corporation, New York, N.Y.**

[**] Term: **14 Years**

[21] Appl. No.: **521,463**

[22] Filed: **May 7, 1990**

[30] **Foreign Application Priority Data**

Dec. 29, 1989 [WO] World Int. Prop. O. ... DM/015.484

[52] U.S. Cl. **D14/205**

[58] Field of Search D14/204-206;
181/129; 379/430, 444; 381/25, 68, 158, 183,
187

[56] **References Cited**

U.S. PATENT DOCUMENTS

- D. 286,772 11/1986 Pope D14/205
- D. 300,133 3/1989 Daidoh et al. D14/205
- D. 305,541 1/1990 Hirose D14/205
- D. 310,081 8/1990 Daido et al. D14/205

- D. 316,861 5/1991 Yoda et al. D14/205
- D. 323,167 1/1992 Yamazaki et al. D14/205

FOREIGN PATENT DOCUMENTS

2176672 12/1986 United Kingdom 381/182

OTHER PUBLICATIONS

ID Sep./Oct. 1987 p. 79 Sony Headphones, top left.

Primary Examiner—Bernard Ansher

Assistant Examiner—Sandra Morris

Attorney, Agent, or Firm—Jack E. Haken

[57] **CLAIM**

The ornamental design for a headphone, as shown.

DESCRIPTION

FIG. 1 is a perspective view of a headphone, showing my new design;

FIG. 2 is a front elevational view thereof;

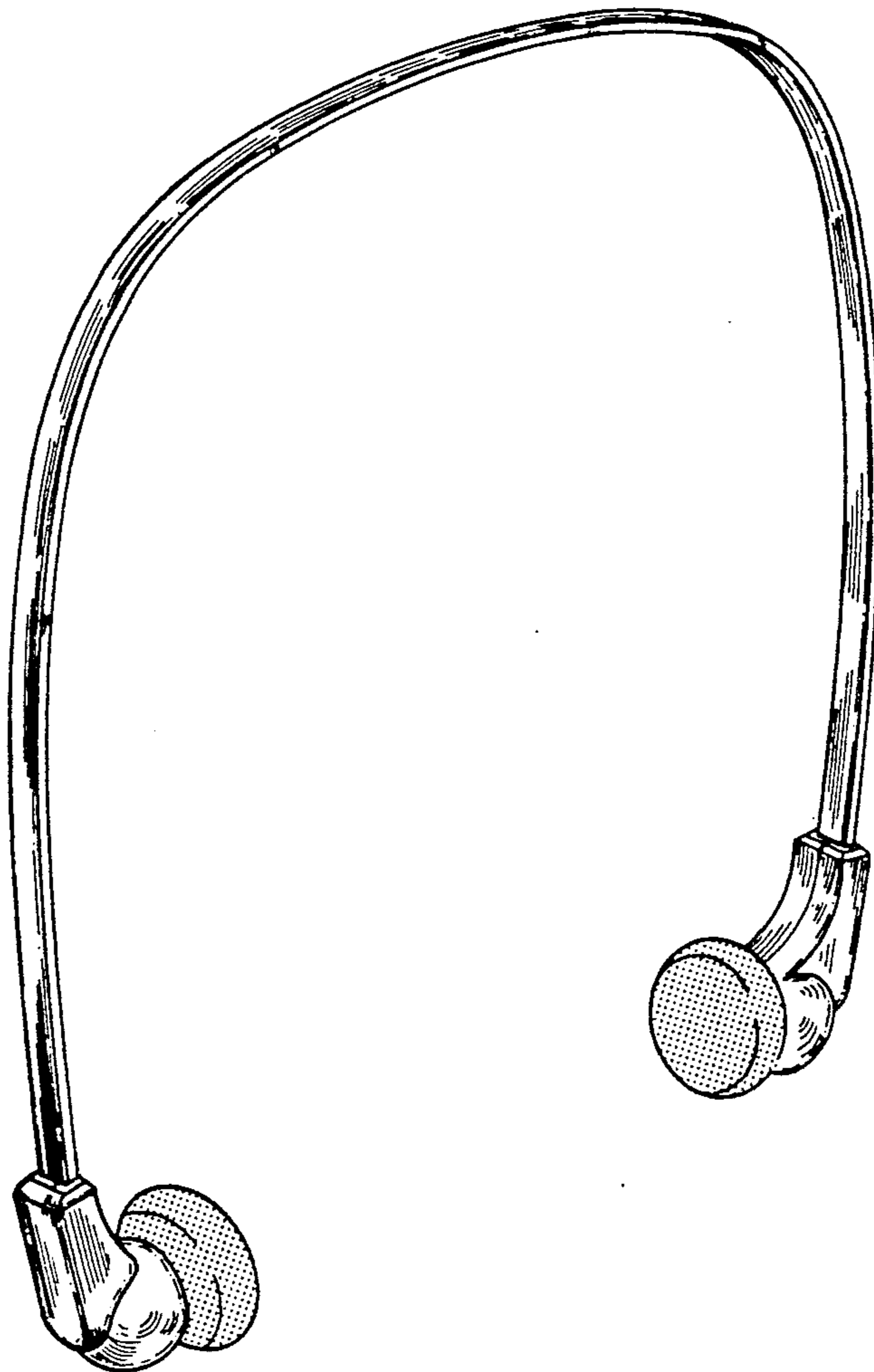
FIG. 3 is a rear elevational plan view thereof;

FIG. 4 is a left side elevational view thereof;

FIG. 5 is a right side elevational view thereof;

FIG. 6 is a top plan view thereof; and,

FIG. 7 is a bottom plan view thereof.



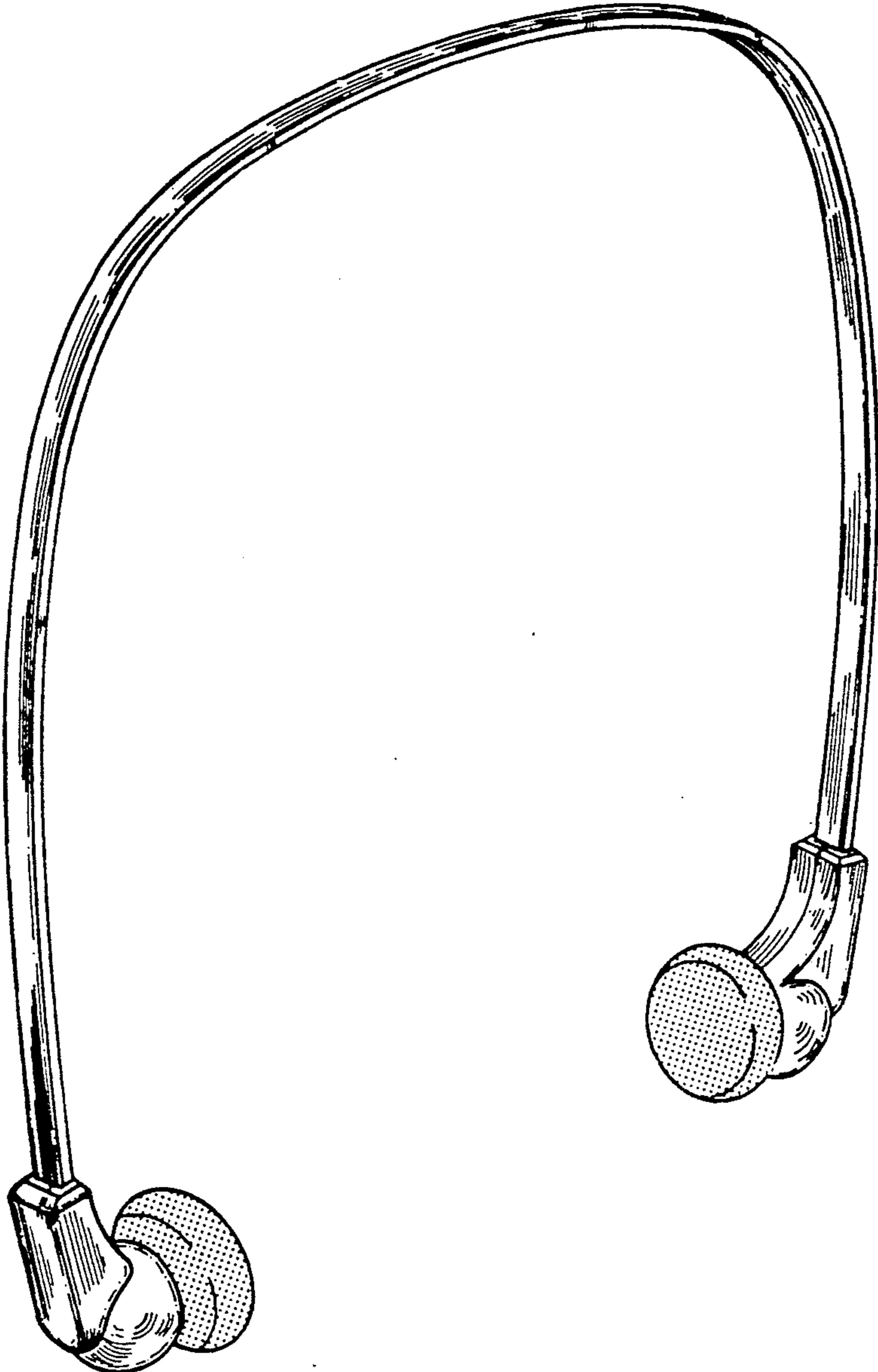


FIG. 1

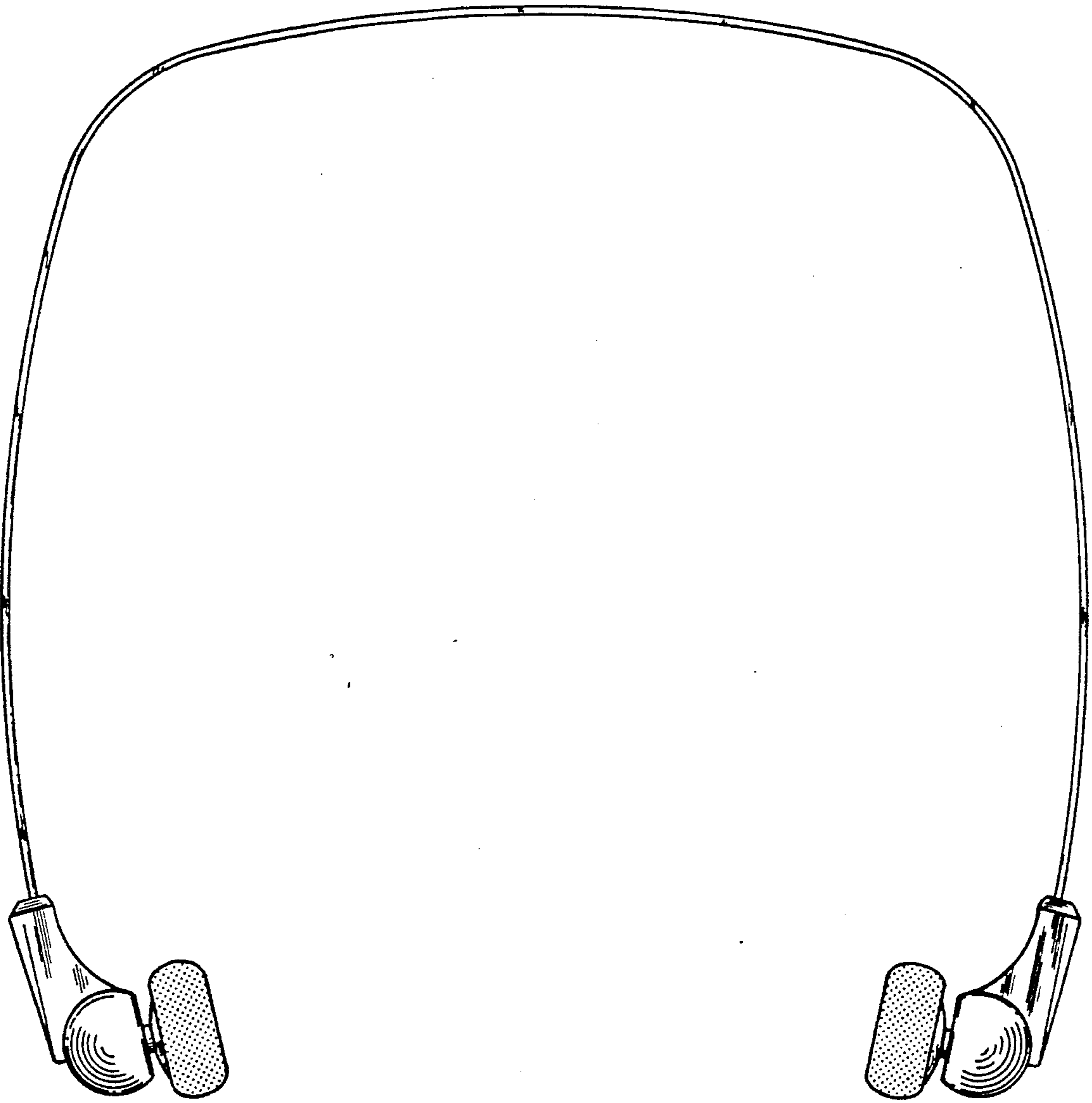


FIG. 2

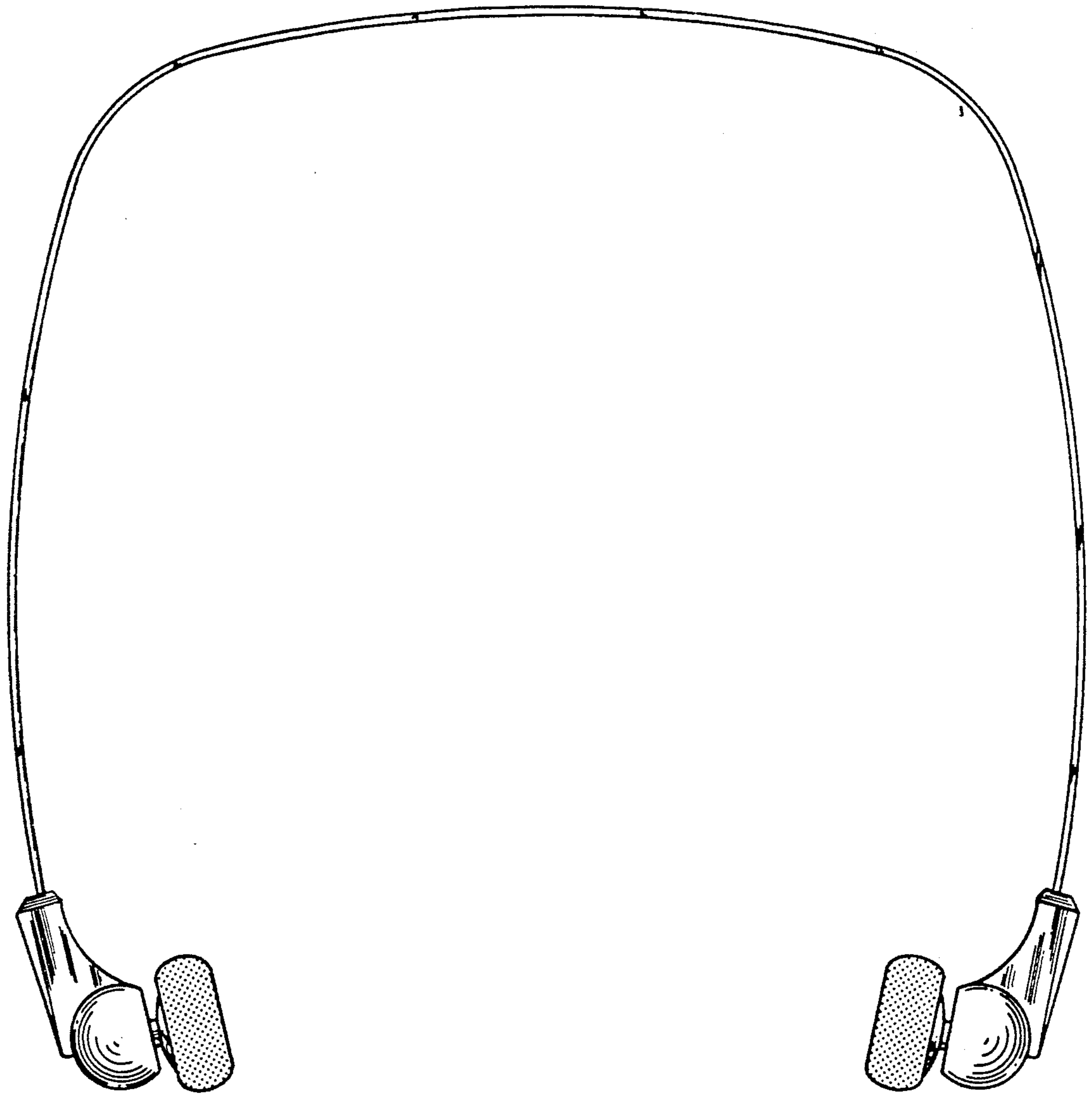


FIG. 3

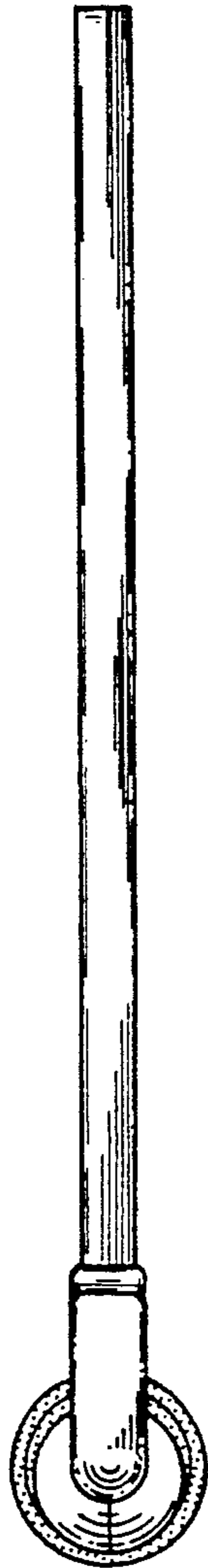


FIG. 4



FIG. 5

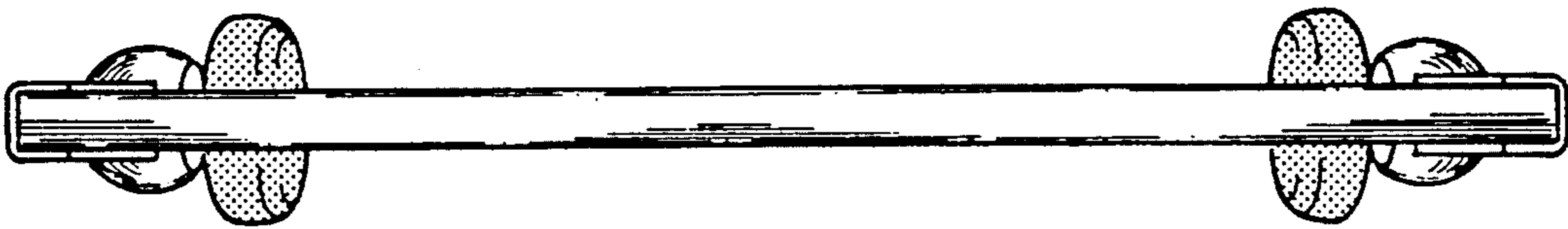


FIG. 6

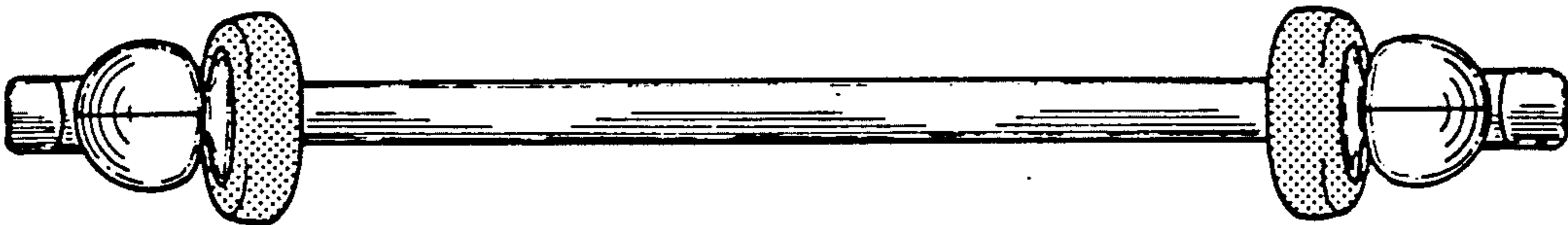


FIG. 7